COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

<table>
<thead>
<tr>
<th>PCB VIEWED FROM TOP SIDE</th>
<th>BOARD #: PMP40328</th>
<th>REV: E1</th>
<th>SUN REV: Not In VersionControl</th>
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</thead>
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<td>TID #: N/A</td>
<td></td>
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<tr>
<td>PLOT NAME = Top Assembly Drawing</td>
<td>GENERATED: 12/5/2017 2:55:45 PM</td>
<td>TEXAS INSTRUMENTS</td>
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